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User Guide for FEBFAN6756MR_T03U065A Evaluation Board

Green-Mode mWSaver[™] PWM Controller for Flyback Converter FAN6756MRMY 65 W (19 V/3.42 A) NB Adapter

Featured Fairchild Product: FAN6756

Direct questions or comments about this evaluation board to: "Worldwide Direct Support"

Fairchild Semiconductor.com





Table of Contents

1.	Intro	duction	3
	1.1.	Description	3
	1.2.	Features	
2.	Func	tional Test Report	5
	2.1.	Input Current	6
	2.2.	Input Power At No-Load Condition	
	2.3.	Turn-On Time	6
	2.4.	DC Output Rising Time	
	2.5.	Line and Load Regulation	7
	2.6.	Efficiency	7
	2.7.	Output Ripple & Noise	
	2.8.	Step Response	10
	2.9.	Over-Current Protection (OCP)	11
	2.10.	Hold-up Time	
	2.11.	Short-Circuit Protection (SCP)	
	2.12.	Brown-in / out Test	
	2.13.	V _{DD} Voltage Level	
	2.14.	Voltage Stress of MOSFET and Rectifiers	
	2.15.	Limit Power Source (LPS)	
	2.16.	HV Discharge Test	
	2.17.	Maximum Output Load for Exiting Standby Mode	
	2.18.	Conducted Emission (EMI)	
	2.19.	Lighting Surges	
	2.20.	Electrostatic Discharge (ESD)	19
3.	Phot	ographs	20
4.	Print	ed Circuit Board	21
5.	Sche	matic	22
6.	Bill	of Materials	23
7.	Tran	sformer / Output Inductor / Heat Sink	25
8.	Revi	sion History	31





This user guide supports the evaluation kit for the FAN6765MR. It should be used in conjunction with the FAN6756MR datasheets as well as Fairchild's application notes and technical support team. Please visit Fairchild's website at <u>www.fairchildsemi.com</u>.

1. Introduction

This document describes a 65W power supply using FAN6756MR. The FAN6756MR mWSaverTM controller targets power adapters that demand extremely low standby power consumption. With innovative mWSaverTM technology, FAN6756MR dramatically reduces standby and no-load power consumption. The AX-CAP[®] technology minimizes losses in the EMI filter stage by eliminating the X-cap discharge resistors while meeting IEC61010-1 safety requirements. Standby Mode switches feedback impedance during Burst Mode operation, which forces the system to operate in a "deep" Burst Mode with minimum switching losses. Proprietary asynchronous jitter decreases EMI emission and built-in synchronized slope compensation allows more stable Peak-Current-Mode control over a wide range of input voltage and load conditions.

1.1. Description

The FAN6756 is a next-generation Green Mode PWM controller with innovative mWSaverTM technology, which dramatically reduces standby and no-load power consumption, conforming to worldwide Standby Mode efficiency guidelines.

An innovative AX-CAP[®] method minimizes losses in the EMI filter stage by eliminating the X-cap discharge resistors while meeting IEC61010-1 safety requirements. Standby Mode clamps feedback voltage and modulates feedback impedance with an impedance modulator during Burst Mode operation, which forces the system to operate in a "deep" Burst Mode with minimum switching losses.

Protections ensure safe operation of power system in various abnormal conditions. Proprietary asynchronous jitter decreases EMI emission and built-in synchronized slope compensation allows more stable Peak-Current-Mode control over wide range of input voltage and load conditions. The proprietary internal line compensation ensures constant output power limit over entire universal line voltage range.

Requiring a minimum number of external components, FAN6756 provides a basic platform that is well suited for cost-effective flyback converter designs that require extremely low standby power consumption.

Specification	Min.	Max.	Unit
Input Voltage	90	264	V _{AC}
Frequency	47	63	Hz
Output Voltage		19	V
Output Current		3.42	А
Total Output Power		65	W

Table 1. Specifications





1.2. Features

- Single-Ended Topologies, such as Flyback and Forward Converters
- mWSaverTM Technology
 - Achieves Low No-Load Power Consumption: Less than 30 mW at 230 V_{AC} (EMI Filter Loss Included)
 - Eliminates X-Capacitor Discharge Resistor Loss with AX-CAP® Technology
 - Linearly Decreases Switching Frequency to 23 KHz
 - Burst Mode Operation at Light-Load Condition
 - Impedance Modulation in Standby Mode for "Deep" Burst Mode Operation
 - Low Operating Current (450 µA) in Standby Mode
 - 500 V High-Voltage JFET Startup Circuit to Eliminate Startup Resistor Loss
- Highly Integrated with Rich Features
 - Proprietary Asynchronous-Jitter to Reduce EMI
 - High-Voltage Sampling to Detect Input Voltage
 - Peak-Current-Mode Control with Slope Compensation
 - Cycle-by-Cycle Current Limiting with Line Compensation
 - Leading-Edge Blanking (LEB)
 - Built-In 8ms Soft-Start
- Advanced Protections
 - Brownout Protection
 - Internal Overload/Open-Loop Protection (OLP)
 - V_{DD} Under-Voltage Lockout (UVLO)
 - V_{DD} Over-Voltage Protection (V_{DD} OVP)
 - Over-Temperature Protection (OTP)
 - Current-Sense Short-Circuit Protection (SSCP)

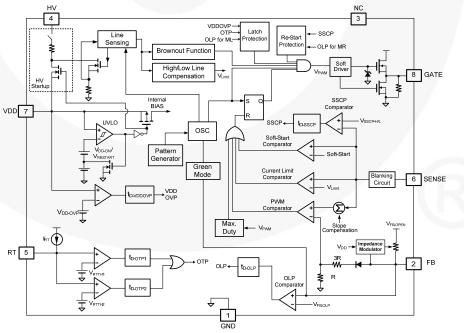


Figure 1. Block Diagram





2. Functional Test Report

Table 2. Summary of Features and Performance

Test Date 2011-07-19 Test Temperature Ambient 1. AC Source: 6220 AC POWER SOURCE 2. Electronic Load: Chroma 63030 3. Power Meter: WT210 4. Oscilloscope: Tektronix TDS3014B 5. Differential Probe: LDP-6002 1. Input current 2. Input power at no-load condition 3. Turn on time 4. DC output rise time 5. Line and load regulation 6. Efficiency 7. Output ripple & noise 8. Step response 9. Over-Current Protection (OCP) 10. Hold-up time 11. Short-Circuit Protection (SCP) 12. Brownin/out test 13. V _{DD} voltage level 14. Voltage stress of MOSFET and rectifiers 15. Limit Power Source (LPS) 16. HV discharge test 17. Maximum output head of axiting Standby Mode	Test Model	FEBFAN6756MR_T03U065A			
Test Equipment 1. AC Source: 6220 AC POWER SOURCE 2. Electronic Load: Chroma 63030 3. Power Meter: WT210 4. Oscilloscope: Tektronix TDS3014B 5. Differential Probe: LDP-6002 1. Input current 2. Input power at no-load condition 3. Turn on time 4. DC output rise time 5. Line and load regulation 6. Efficiency 7. Output ripple & noise 8. Step response 9. Over-Current Protection (OCP) 10. Hold-up time 11. Short-Circuit Protection (SCP) 12. Brownin/out test 13. V _{DD} voltage level 14. Voltage stress of MOSFET and rectifiers 15. Limit Power Source (LPS) 16. HV discharge test	Test Date	2011-07-19			
Test Equipment 2. Electronic Load: Chroma 63030 3. Power Meter: WT210 4. Oscilloscope: Tektronix TDS3014B 5. Differential Probe: LDP-6002 1. Input current 2. Input power at no-load condition 3. Turn on time 4. DC output rise time 5. Line and load regulation 6. Efficiency 7. Output ripple & noise 8. Step response 9. Over-Current Protection (OCP) 10. Hold-up time 11. Short-Circuit Protection (SCP) 12. Brownin/out test 13. V _{DD} voltage level 14. Voltage stress of MOSFET and rectifiers 15. Limit Power Source (LPS) 16. HV discharge test	Test Temperature	Ambient			
2. Input power at no-load condition 3. Turn on time 4. DC output rise time 5. Line and load regulation 6. Efficiency 7. Output ripple & noise 8. Step response 9. Over-Current Protection (OCP) 10. Hold-up time 11. Short-Circuit Protection (SCP) 12. Brownin/out test 13. V _{DD} voltage level 14. Voltage stress of MOSFET and rectifiers 15. Limit Power Source (LPS) 16. HV discharge test	Test Equipment	 Electronic Load: Chroma 63030 Power Meter: WT210 Oscilloscope: Tektronix TDS3014B 			
 17. Maximum output load of exiting standby Mode 18. Conducted emission 19. Lighting surges 20. Electrostatic Discharge (ESD) 	Test Items	 Input power at no-load condition Turn on time DC output rise time Line and load regulation Efficiency Output ripple & noise Step response Over-Current Protection (OCP) Hold-up time Short-Circuit Protection (SCP) Brownin/out test V_{DD} voltage level Voltage stress of MOSFET and rectifiers Limit Power Source (LPS) HV discharge test Conducted emission Lighting surges 			





2.1. Input Current

2.1.1 Test Conditions

The input current at max-load is recorded after meter readings are stable. The specification for input current at maximum load condition is under 2 A.

2.1.2 Test Results

Input Voltage	Input Current	Specification	
90 V / 60 Hz	1.595 A	<2 A	
264 V / 50 Hz	0.689 A		

2.2. Input Power At No-Load Condition

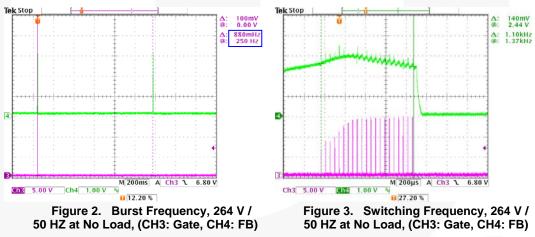
2.2.1 Test Conditions

The no-load input power and output voltage measurements are recorded after the input power is stable. The specification for input power at no-load condition is under 30 mW.

2.2.2 Test Results

Input Voltage	Input Wattage	Burst Frequency	Output Voltage	Specification
230 V / 50 Hz	24 mW	0.95 Hz	18.8~19.2 V	<30 mW
264 V / 50 Hz	27 mW	0.88 Hz	18.8~19.2 V	<30 mw

2.2.3 Measured Waveforms



2.3. Turn-On Time

2.3.1 Test Conditions

The electronic load is set to the maximum continuous output current. The specification for turn-on time at the maximum load condition is under three seconds.

2.3.2 Test Results

Input Voltage	Turn-On Time	Specification
90 V / 60 Hz	1.48 s	<2.2
264 V / 50 Hz	0.44 s	<3 s





2.4. DC Output Rising Time

2.4.1 Test Conditions

The electronic load is set to the maximum continuous output current. The specification for DC output rising time from 10% to 90% of the maximum load condition is within 20 ms.

2.4.2 Test Results

Input Voltage	Maximum Load	Specification
90 V/60 Hz	9.76 ms	<20 ms
264 V/50 Hz	3.41 ms	<20 ms

2.5. Line and Load Regulation

2.5.1 Test Conditions

Output voltage measurements are recorded after output voltage is stable. The specification for line and load regulation at no load and full load condition is under 5%.

2.5.2 Test Results

Input Voltage	Output Voltage at 0% Load	Output Voltage at 100% Load	Load Regulation	Specification
90 V / 60 Hz	19.07 V~18.83 V	18.908 V	0.85%	
115 V / 60 Hz	19.06 V~18.81 V	18.776 V	1.49%	
230 V / 50 Hz	19.03 V~18.82 V	18.868 V	0.85%	<5%
264 V / 50 Hz	19.03 V~18.81 V	18.866 V	0.86%	
Line Regulation	1.37%	0.69%		

2.6. Efficiency

2.6.1 Test Conditions

Efficiency measurements are recorded after meter readings are stable. The specification for the average efficiency at 25%, 50%, 75%, and 100% of full load condition is above 86%, while the specification for efficiency at light-load condition is above 60%.

2.6.2 Test Results

20AWG Output Cable without Remote Sense

Input Voltage	25% (0.855 A)	50% (1.71 A)	75% (2.565 A)	100% (3.42 A)	Average	Specification
90 V / 60 Hz	87.65%	87.29%	86.04%	84.38%	86.34%	
115 V / 60 Hz	88.48%	88.58%	87.45%	86.22%	87.68%	$A_{\rm MR} > 960/$
230 V / 50 Hz	88.00%	87.89%	87.92%	87.47%	87.82%	Avg.> 86%
264 V / 50 Hz	87.72%	88.24%	87.88%	87.46%	87.83%	





Input Voltage	10.4 mA Loading (0.199 W)	12 mA Loading (0.232 W)	25.5 mA Loading (0.495 W)	30 mA Loading (0.582 W)	Specification
90 V/60 Hz	72.17%	74.51%	80.50%	81.89%	
115 V/60 Hz	71.58%	74.27%	80.69%	82.01%	>60%
230 V/50 Hz	67.31%	68.34%	77.03%	78.89%	200 %
264 V/50 Hz	65.34%	67.71%	75.38%	77.32%	

2.7. Output Ripple & Noise

2.7.1 Test Conditions

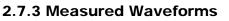
Output ripple and noise are measured in maximum and minimum load condition using a 20 MHz-bandwidth oscilloscope. The output is shunted with a 10 μ F capacitor and a high-frequency 0.1 μ F capacitor. The minimum load is defined by the minimum normal operation loading for FAN6756MR. If the output load is under the minimum load, FAN6756 may enter Standby Mode operation.

2.7.2 Test Results

Input Voltage	Max. Load (3.42 A)	Min. Load (6 mA)	No Load
90 V / 60 Hz	88 mV	34 mV	348 mV
115 V / 60 Hz	64 mV	41 mV	332 mV
230 V / 50 Hz	47 mV	80 mV	384 mV
264 V / 50 Hz	46 mV	78 mV	404 mV







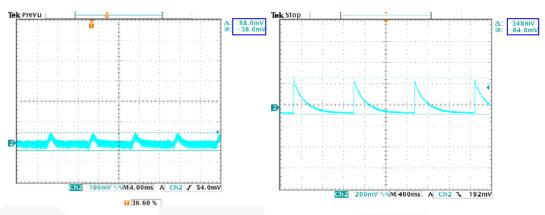
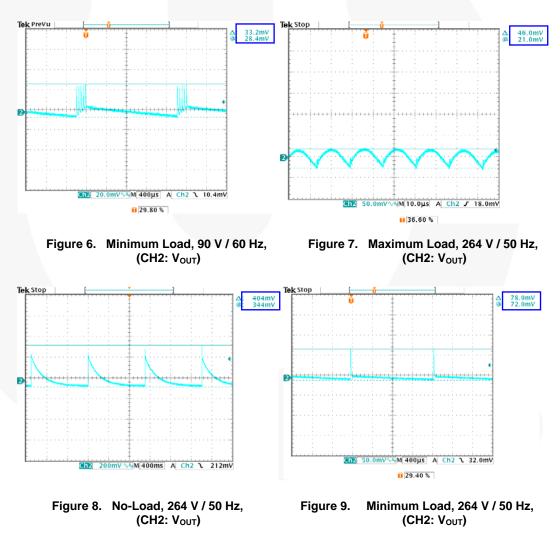


Figure 4. Maximum Load, 90 V / 60 Hz, (CH2: V_{OUT})

Figure 5. No-Load, 90 V /60 Hz, (CH2: VOUT)







2.8. Step Response

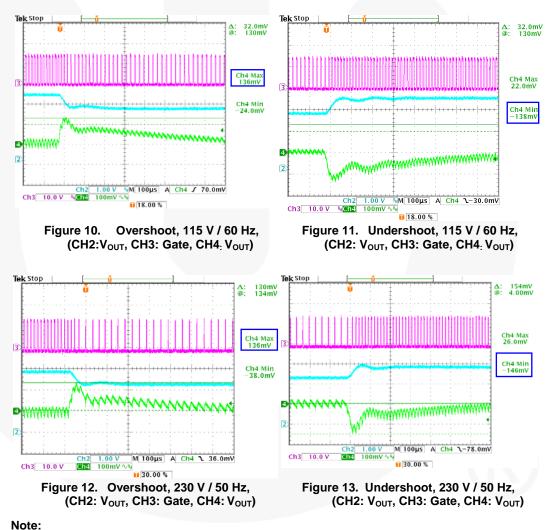
2.8.1 Test Conditions

The output load changes from 20% to 80% of full load at 5ms duty cycle with a slew rate of 2.5 A/ μ s. The specification for overshoot and under hoot is under 250 mV.

2.8.2 Test Results

Input Voltage Overshoot		Undershoot	Specification
115 V / 60 Hz	136 mV	138 mV	<250 mV
230 V / 50 Hz	136 mV	146 mV	<250 IIIV

2.8.3 Measured Waveforms



1. CH2 = DC coupling, CH4 = AC coupling.





2.9. Over-Current Protection (OCP)

2.9.1 Test Conditions

The electronic load is set in Constant Current (CC) Mode and the output load is gradually increased until the Over-Current Protection (OCP) is triggered. The specification for OCP is under 5.5 A.

2.9.2 Test Results

Input Voltage	Output Current	Specification
90 V / 60 Hz	4.400 A	
115 V / 60 Hz	4.740 A	<5.5 A
230 V / 50 Hz	4.875 A	N 6.62
264 V / 50 Hz	4.830 A	

2.10. Hold-up Time

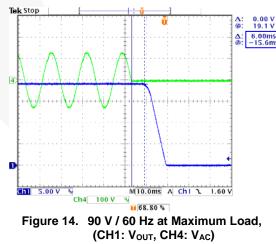
2.10.1 Test Conditions

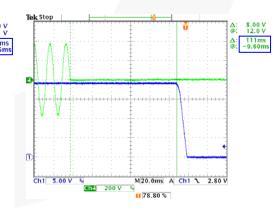
The electronic load is set to be the maximum continuous output load. The AC waveform should be turned-off at zero degree. The hold-up time is measured time from AC-off to the falling edge of output voltage.

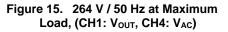
2.10.2 Test Results

Input Voltage	Hold-up Time
90 V / 60 Hz	6.0 ms
115 V / 60 Hz	13.2 ms
230 V / 50 Hz	81.6 ms
264 V / 50 Hz	111.0 ms

2.10.3 Measured Waveforms







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2.11. Short-Circuit Protection (SCP)

2.11.1 Test Conditions

The output is pre-short and the average input power is measured after stabilization of the meter. The specification for average input power in short-circuit protection condition is under 5 W.

2.11.2 Test Results

Input Voltage	Average Input Power at Maximum Loading	Specification
90 V / 60 Hz	0.95 W	<5 W
264 V / 50 Hz	1.87 W	~5 VV

2.12. Brown-in / out Test

2.12.1 Test Conditions

The electronic load is set to the maximum continuous output current. The HV pin resistor is set to 150 k Ω and 200 k Ω , respectively. The brownout level is measured by decreasing the input voltage from 85 V gradually; while the brown-in level is measured by increasing the input voltage gradually after brownout. The specification for the difference of brown-in and brown-out level at maximum output load condition is under 10 V.

2.12.2 Test Results

R _{HV}	Brown-in	Brownout	∆V= Brown-in – Brownout
150 kΩ	66 V	63 V	3 V
200 kΩ	78 V	74 V	4 V

2.13. V_{DD} Voltage Level

2.13.1 Test Conditions

The V_{DD} voltage levels are measured while the output load is increased from no load, minimum load, and maximum load to near over-power protection (OPP). The maximum value of V_{DD} at output-short condition is recorded.

2.13.2 Test Results

	No Load	Min. Load	Max. Load	Near OPP	Output Short
90 V / 60 Hz	7.1~16.6 V	16.4 V	22.2 V	23.4 V	22.5 V
264 V / 50 Hz	7.1~16.6 V	16.3 V	21.2 V	22.3 V	21.2 V





2.14. Voltage Stress of MOSFET and Rectifiers

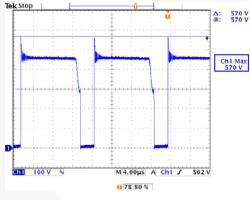
2.14.1 Test Conditions

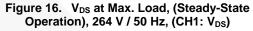
The peak voltage of the MOSFET (V_{DS}) and secondary rectifier (V_{KA}) is measured at 264 V input voltage and maximum output load. Measurements are taken in steady-state, output short, startup, and turn-off conditions. The specification for the voltage rating of MOSFET and rectifiers are under 650 V and 150 V, respectively.

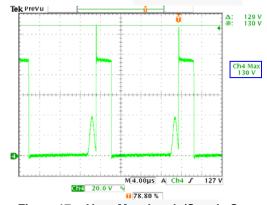
2.14.2 Test Results

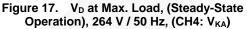
	Stress on MOSFET (V _{DS})	Rating	Stress on Output Rectifier (V _{KA})	Rating
264 V / 50 Hz, Max. Load (Steady-State)	570 V		130 V	
264 V / 50 Hz, Max. Load, (Output Short)	596 V	650 V	122 V	150 V
264 V / 50 Hz, Max. Load, (Startup)	592 V	050 V	124 V	150 V
264 V / 50 Hz, Max. Load, (Turn-Off)	596 V		128 V	

2.14.3 Measured Waveforms













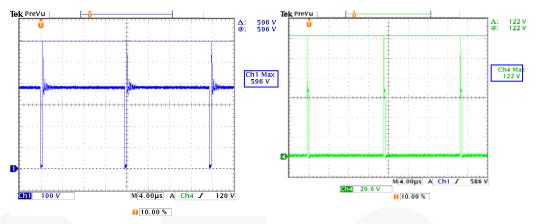


Figure 18. V_{DS} at Max. Load, (Output Short), Figure 19. V_D at Max. Load, (Output Short), 264 V / 50 Hz, (CH1: V_{DS})

264 V / 50 Hz, (CH4: VKA)

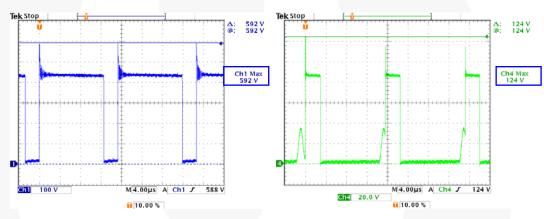


Figure 20. V_{DS} at Max. Load, (Startup), 264 V / Figure 21. V_D at Max. Load, (Startup), 264 V / 50 Hz, (CH1: V_{DS})

50 Hz, (CH4: VKA)

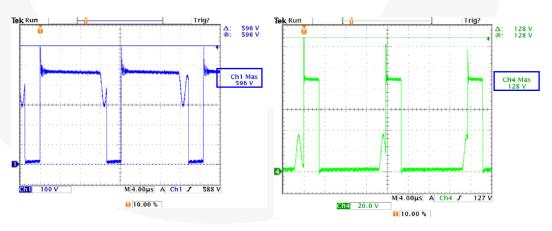


Figure 22. V_{DS} at Max. Load, (Turn-Off), 264 V Figure 23. V_D at Max. Load, (Turn-Off), 264 V / 50 Hz, (CH1: V_{DS})

/ 50 Hz, (CH4: VKA)





2.15. Limit Power Source (LPS)

2.15.1 Test Conditions

The sense pin is shorted to ground at first then the system is turned-on to check if the Limit Power Source (LPS) function is triggered. If LPS is triggered, the system enters Auto-Recovery Mode.

2.15.2 Test Results

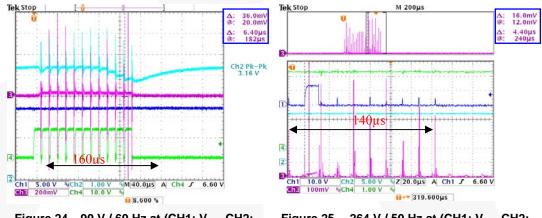
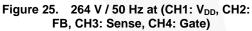


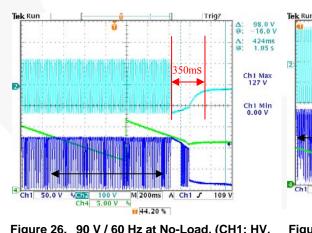
Figure 24. 90 V / 60 Hz at (CH1: V_{DD}, CH2: FB, CH3: Sense, CH4: Gate)



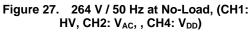
2.16. HV Discharge Test

2.16.1 Test Conditions

Unplug the power line and measure the discharge time of the X-cap at no-load condition. The discharge time must be less than 1 second when X-cap voltage reaches 37% of its peak value.

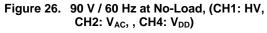






0.000 %

GH 5.00 V



Trigi

326 V

400mS

A Ch1 J

4.40 V 11.5 V

∆: 444ms @: 1.73 s

> Ch1 Max 372 V

Ch1 Min 4.00 V





2.17. Maximum Output Load for Exiting Standby Mode

2.17.1 Test Conditions

Increase output load gradually until exiting Standby Mode. The specification for the maximum output load of exiting Standby Mode is under 10 mA.

2.17.2 Test Results

Input Voltage	Input Voltage Enter Normal Mode Loading	
90 V / 60 Hz	4.5 mA (87.3 mW)	
115 V / 60 Hz	4.5 mA (87.3 mW)	<10 mA
230 V / 50 Hz	6.0 mA (116.4 mW)	<10 IIIA
264 V / 50 Hz	6.0 mA (116.4 mW)	

2.18. Conducted EMI

2.18.1 Test Conditions

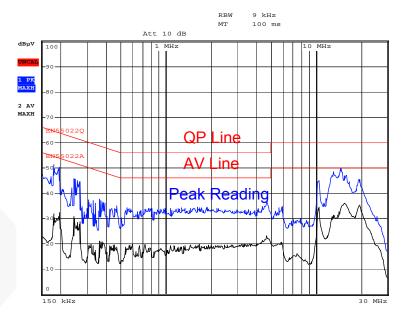
Input voltage is set to 115 V and 230 V, respectively. The output ground is not connected to EMI ground (earth ground). The specification for conducted emission of peak reading at maximum load condition is under 6dB of QP line.





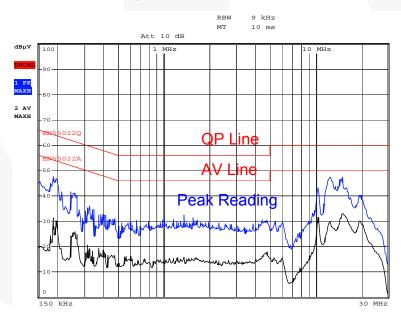


2.18.2 Test Results



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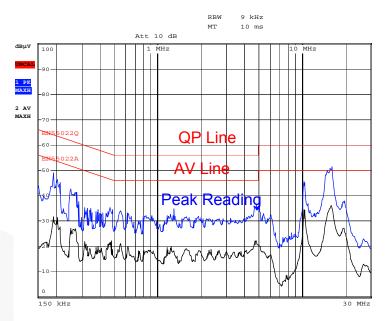


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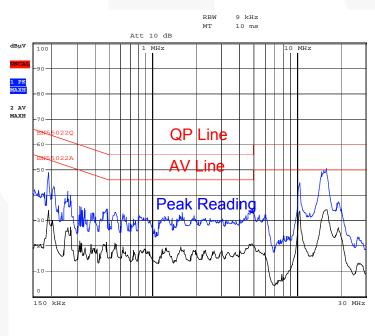






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2.19. Lightening Surges

2.19.1 Test Conditions

- 1. Input voltage: 230 V; Output power: 65 W
- 2. Combination wave: 1.2/50 µs open-circuit voltage and 8/20 µs short-circuit current.
- 3. The ground connection of the output terminal is connected to earth ground.
- 4. Mode impendence set: L-to-N: 2 Ω ; L-to-PE, and N-to-PE: 12 Ω .
- 5. Test voltage: 6 kV at L-to-PE, and N-to-PE; 1 kV at L-to-N.
- 6. Phase angle: 0°, 90°, 180°, and 270°
- 7. Polarity: positive and negative.
- 8. Pulse repetition rate: 20 s.
- 9. No disruption of functionality in three test samples.

2.19.2 Test Results

Mode	Polarity	Phase	Voltage	Condition
	±	0°		Pass
L-N	±	90°	1kV	Pass
L-IN	±	180°	IKV	Pass
	±	270°		Pass
	±	0°		Pass
L-PE	±	90°	6kV	Pass
L-FC	±	180°		Pass
	±	270°		Pass
	±	0°		Pass
N-PE	±	90°	6kV	Pass
	±	180°		Pass
	±	270°		Pass

2.20. Electrostatic Discharge (ESD)

2.20.1 Test Conditions

- 1. Input voltage: 230 V; output power: 65 W.
- 2. Test voltage: 16.5 kV at air discharge and 8.8 kV at contact discharge.
- 3. Polarity: positive and negative.
- 4. The ground connection of the output terminal is not connected to AC line ground.
- 5. No disruption of functionality in three test samples.

2.20.2 Test Results

Air Discharge ±16.5 kV		Contrast Discharge ±8.8 kV	
Pass	Pass Pass		Pass





3. Photographs



Figure 32. Top View

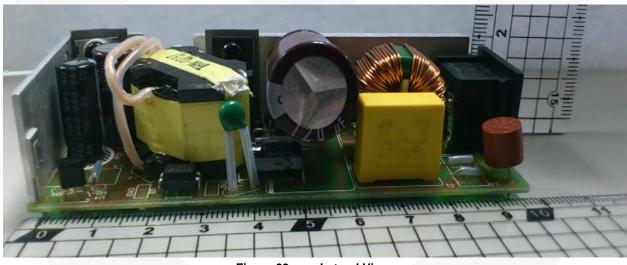


Figure 33. Lateral View





4. Printed Circuit Board

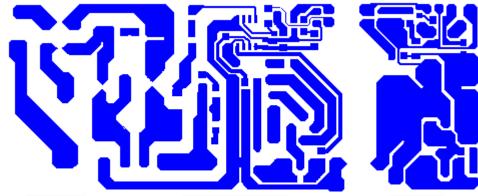


Figure 34. Bottom Layer

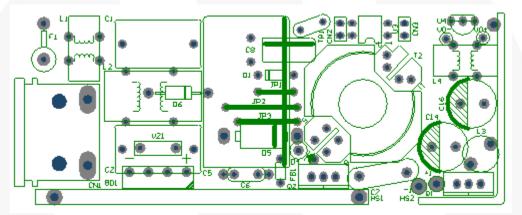


Figure 35. Top Assembly

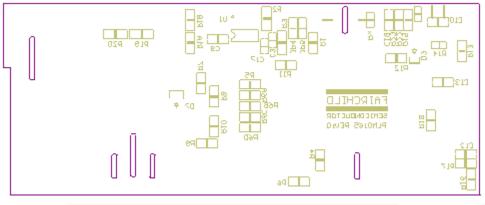
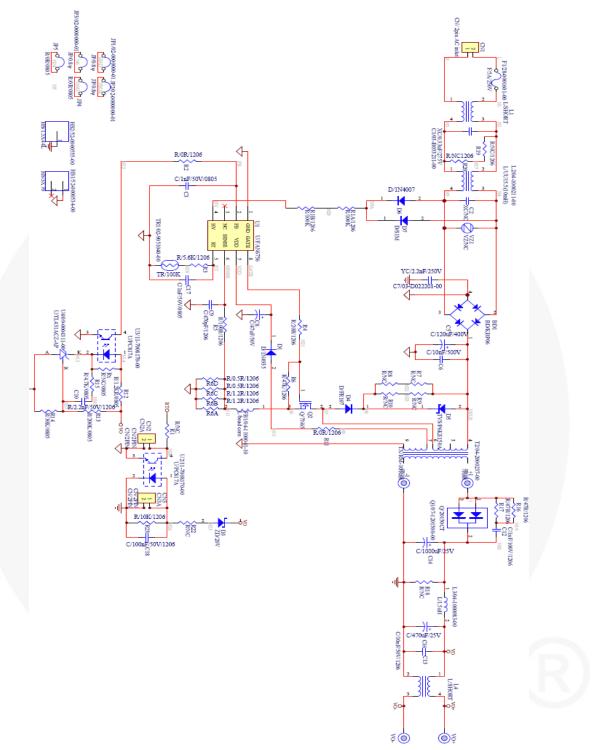


Figure 36. Bottom Assembly





5. Schematic









6. Bill of Materials

Reference	Qty.	Part Number	Value	Description	Manufacturer
L1, L4, JP1, JP2, JP3, JP6	8		0.8ψ (mm)	Jumper Wire	STD
JP4, JP5	2	SMD 0805	0 Ω ±5%	Resistor	STD
R15	1	SMD 0805	4.7 kΩ ±1%	Resistor	STD
R14	1	SMD 0805	30 kΩ ±5%	Resistor	STD
R13	1	SMD 0805	200 kΩ ±5%	Resistor	STD
R2, R11	2	SMD 1206	0 Ω ±5%	Resistor	STD
R6A, R6B	2	SMD 1206	1.2 Ω ±5%	Resistor	STD
R6C, R6D	2	SMD 1206	0.5 Ω ±5%	Resistor	STD
R4	1	SMD 1206	20 Ω ±5%	Resistor	STD
R16, R17	2	SMD 1206	47 Ω ±5%	Resistor	STD
R5	1	SMD 1206	100 Ω ±5%	Resistor	STD
R12	1	SMD 1206	1.2 kΩ ±5%	Resistor	STD
R3	1	SMD 1206	5.6 kΩ ±1%	Resistor	STD
R23	1	SMD 1206	10 kΩ ±1%	Resistor	STD
R6	1	SMD 1206	47 kΩ ±5%	Resistor	STD
R1A, R1B	2	SMD 1206	100 kΩ ±5%	Resistor	STD
TR1	1	TTC05104L	100 kΩ	Thermistor, B25/50=4400 K	TKS
C6	1		10 nF +80/-20% 500 V	Capacitor, Ceramic, Thru-Hole	STD
C17, C3	2	SMD 0805	1 nF ±10% 50 V	Capacitor, Ceramic, X7R	STD
C18	1	SMD 1206	100 nF ±10% 50 V	Capacitor, Ceramic, X7R	STD
C12	1	SMD 1206	1 nF ±10% 100 V	Capacitor, Ceramic, X7R	STD
C13	1	SMD 1206	10 nF ±10% 50 V	Capacitor, Ceramic, X7R	STD
C9	1	SMD 1206	470 pF ±10% 50 V	Capacitor, Ceramic, X7R	STD
C10	1	SMD 1206	2.2 nF ±10% 50 V	Capacitor, Ceramic, X7R	STD
C8	1		47 µF 50 V	Capacitor, Electrolytic, 105°C, 6.3x11, LHK	JACKCON
C14	1		1000 µF 25 V	Capacitor, Electrolytic, 105°C, 10x20, KMG	NCCNippon Chemi-con
C5	1		120 μF 400 V	Capacitor, Electrolytic, 105°C, 18x31.5, KMG	NCCNippon Chemi-con
C16	1		47 0µF 25 V	Capacitor, Electrolytic, 105°C, 8x20, LHK	JACKCON
C1	1	HQX334K275I20SANY FY	$0.33 \ \mu\text{F} \pm 10\% \ 275 \ V_{AC}$	Capacitor, X2 Type, Interference Suppression	uTx
C7	1	CS13- E2GA332MYVSA	222P 250 V ±20%	Capacitor, Y2 Type, Ceramic	TDK
L3	1	TRN0083	1.6 µH	Inductor, R4X12	SEN HUEI
L2	1	TRN0211	9 mH	Common-Mode Choke, RT181007	SEN HUEI
FB1	1	MCH0041		BEAD, C8B, 3.5x3x0.8+T	Bullwill





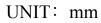
Reference	Qty.	Part Number	Value	Description	Manufacturer
D4, C7	2	MCH0040		BEAD, C8B, 3.5x3.2x1.0	Bullwill
T2	1	TRN0237	510 µH	Transformer, RM-10	SEN HUEI
D4	1	FR107	1 A, 700 V	Diode, Fast Recovery, DO-41	СР
D6	1	1N4007	1 A, 1000 V	Diode, General Purpose, DO-41	Fairchild Semiconductor
D1	1	1N4935	1 A, 200 V	Diode, Fast Recovery, DO-41	Fairchild Semiconductor
D7	1	S1M	1 A, 1000 V	Diode, General Purpose, SMA/DO-214AC	Fairchild Semiconductor
BD1	1	2KBP06M	2 A, 600 V,	Bridge Rectifier, KBPM	Fairchild Semiconductor
Q1	1	MBR20150CT	20 A, 150 V	Dual Schottky Rectifier,TO- 220	Fairchild Semiconductor
D3	1		20 V, 1/2 W	Diode, Zener, SMD	STD
U4	1	TL431ACZ	±1%, 2.5 V	Shunt Regulator, TO-92R	Fairchild Semiconductor
Q2	1	FQPF7N65C	7 A, 650 V	MOSFET, TO-220F	Fairchild Semiconductor
U3	1	FOD817A	Current Transfer Ratio: 80–160%	Opto-Coupler, DIP-B	Fairchild Semiconductor
U1	1	FAN6756MRMY		PWM Controller, SOP-8	Fairchild Semiconductor
F1	1	MET005	250V 5A	Fuse, Time-Lag, Radial Lead, ψ8.35xH7.7	CONQUER
D5	1	P6KE150A	Breakdown Voltage=143~158 V	TVS, DO-15	Fairchild Semiconductor
CN1	1	R-201SN90(B06)		AC Socket, INLET 2P 90°	STD
HS1	1	MCH0534		Heat Sink, 70(L)x20(H)x3(W)mm	Hardware
HS2	1	MCH0555		Heat Sink, L Type 40x18(L)x 20(H)x1.6(W)mm	Hardware
PWB	1	PLM0165 REV 0		1 Layer, PLM0165 REV 0	PCB

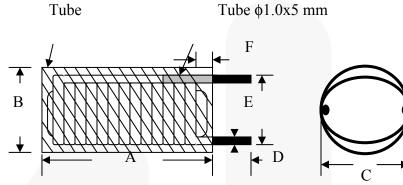




7. Transformer / Output Inductor / Heat Sink SPECIFICATION APPROVAL

1.DIMENSION:





А	14 max.
В	9.0 max.
С	6.0±1
D	3.5±0.3
Е	φ0.8±0.1
F	1-2

2.ELECTRICL SPECIFICATON: at 1 KHz,0.3 V

2.1 INSDUCTANCE: 1.6 µH min

2.2 DC RESISTANCE: 11 mOhm max

2.3 TURN & WIRE : \$\oplus 0.8x12.5TS(ref)

MATERIALS LIST :

COMPONENT	MAT'L	MANUFACTURE	UL FILE NO.
1.CORE	S6,SGB or equal	Ferrite core R4x12 Jaw Shianq.	
	THFN-216 130°C	Ta Ya Electronic Wire & Cable Co., Ltd.	E197768
2.WIRE	UEWN/U 130°C	Pacific Electronic Wire & Cable Co., Ltd.	E201757
	UEY 130°C	Chuen Yih Wire Co., Ltd.	E174837
3.TUBE	UL TUBE	Shengzhen Changyuan Co., Ltd.	E180908
4.TERMINALS	Tin coated- Copper wire	Will Fore Special Wire Corp.	
5.SOLDER	96.5% Su 3% Ag,0.5% Cu	Xin Yuan Co., Ltd.	

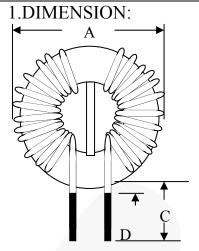
UNIT	m/m	DRAWN CHECK		TITLE	
TEL	(02)29450588	Ci wun Chen Guo long Huang		IDENT N O.	TRN-0083
FAX	(02)29447647				
	ane 128, Sec. 2,	SEN HUEI INDUSTRIAL CO.,LTD.		D W G	10026
Singnan Rd., Jhonghe City, Taipei		SEN HOEF INDUSTRIAL CO., LTD.		NO.	10020
County 235	, Taiwan (R.O.C.)				

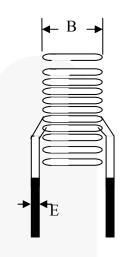




UNIT: mm

SPECIFICATION APPROVAL





Α	25 max.
В	15 max.
С	5 ±1
D	1 max
Е	φ0.65±0.1

2.RLECTRICL SPECIFICATION: at 1kHz, 1V

2.1 INDUCTANCE : L1=L2 : 9.0 mH min.

2.2 DC RESISTANCE : L1=L2 : 0.78 Ohm max.

2.3 TURN & WIRE : L1=L2 : \$\overline{0.65}\$ x 37.5TS

MATERIALS LIST :

COMPONENT	MAT'L	MANUFACTURE	UL FILE NO.
1.CORE	T18x10x7	Core T18x10x7 TOMITA.	
	THFN-216	Ta Ya Electronic Wire & Cable Co., Ltd.	E197768
	UEWN/U	Pacific Wire & Cable Co., Ltd.	E201757
2.WIRE	UEWE	Tai-l Electronic Wire & Cable Co., Ltd.	E85640
	UWY	Jang Shing Wire Co., Ltd.	E174837
3.SOLDER	96.5% Sn,3% Ag,0.5% Cu,	Xin Yuan Co., Ltd.	

UNIT	m/m	DRAWN	CHECK	TITLE	(R)
TEL	(02)29450588	Ci wun Chen	Guo long Huang	IDENT N O.	TRN-0211
Singnan R	(02)29447647 ane 128, Sec. 2, d., Jhonghe City, Taipei 5, Taiwan (R.O.C.)	SEN HUEI INDUSTRIAL CO.,LTD.		DWG NO.	10060





SPECIFICATION APPROVAL **1.DIMENSION:** Unit: mm F Æ 30MAX Tape 2 truns 21 MAX 3±0.5 0.6±0.1 S SIDE VIEW ELEVATION VIEW **TRN-0237** 30MAX Past label on the top of transformer, and the wording peak faces pin 1 &pin 12 3.5**±0.2** 7.2±0,2 BOTTOM VIEW NOTE: 1) Pin 8 No. 2) Pin 5 cut off 2/3. 3) Add insulation tape *2 turns to fix core and bobbin. UNIT DRAWN CHECK TITLE TRANS m/m IDENT TEL (02)29450588 Ci wun Chen **TRN-0237** Guo long Huang NO. FAX (02)29447647 No.26-1, Lane 128, Sec. 2, DWG I9903 SEN HUEI INDUSTRIAL CO., LTD.

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Taipei County 235, Taiwan

(R.O.C.)

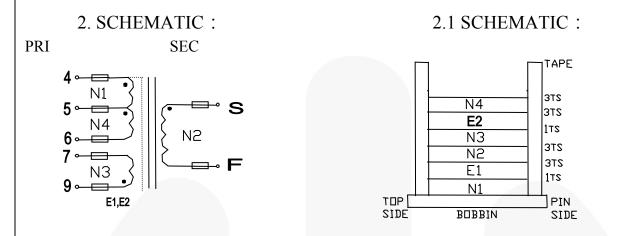
KB773-9192

NO.





SPECIFICATION APPROVAL



Note: All wires shield wields 0.2 ϕ lead, and Teflon pipe connect to pin4.

2.3 WINDING

STEP	WINDING	MATERIAL	START-FINIS	H TURN	NS TAP	PE REMARK
1	N1	2UEW- ф 0.50×1F	4-5	19 ^{TS}	⁵ 1 ^{TS}	5
2	E1	T0.025×7 mm	-4	1.2 ^T	s 3 ^{TS}	Adhesive tape of copper foil
3	N2	ТЕХ-Е - ф 0.90×11	P S-F	8 ^{TS}	3 ^{TS}	5
4	N3	2UEW- ф 0.40×1F	9-7	7 ^{TS}	1 ^{TS}	⁵ Middle densely circles
5	E2	T0.025×7 mm	-4	1.2 ^T	s 3 ^{TS}	Adhesive tape of copper foil
6	N4	2UEW- ф 0.50×1F	5-6	19 ^{TS}	⁵ 3 ^{TS}	5
UNIT	m/m	DRAWN	CHECK		TITLE	TRANS
TEL	(02)2945058	Ci wun Cher	n Guo long H	uang	IDENT N O.	TRN-0237
FAX	(02)2944764	.7				
No.26-1, Lane 128, Sec. 2, Singnan Rd., Jhonghe City, Taipei County 235, Taiwan (R.O.C.)		SEN HUEI IN	SEN HUEI INDUSTRIAL CO.,LTD.		DWG NO.	19903 KB773-9192





SPECIFICATION APPROVAL

3.ELECTRICAL SPECIFICATION:

3.1 Inductance test: at 1 kHz ,1 V

L4-6=510 µH±5%

3.2 Leakage inductance: at 1 kHz ,1 V

P(4-6): 20 μH max. (shorted A,B)

3.3 DC Resistance test at 25°C

P(4-6) : 23 mOhm max.

3.4 Hi-pot test:

AC 3.0 kV / 60 Hz / 0.5 mA hi-pot for one minute between pri. to sec.

AC 1.5 kV / 60 Hz / 0.5 mA hi-pot for one minute between pri. to core.

AC 1.5 kV / 60 Hz / 0.5 mA hi-pot for one minute between sec. to core.

3.5 Insulation test:

The insulation resistance is between pri. to sec. and windings to core measured by DC 500 V, must Be over 100 MOhm.

3.6 Terminal strength:

1.0 Kg on terminals for 30 seconds, test the breakdown.

UNIT	m/m	DRAWN CHECK		TITLE	TRANS
TEL	(02)29450588	Ci wun Chen Guo long Huang		IDENT NO.	TRN-0237
FAX	(02)29447647				
Singnan R	Lane 128, Sec. 2, Rd., Jhonghe City, unty 235, Taiwan SEN HUEI INDUSTRIAL CO.,		TRIAL CO., LTD.	DWG NO.	I9903 KB773-9192





SPECIFICATION APPROVAL

MATERIALS LIST :

CO	MPONENT	MAT'L		MANUFACTURE		FILE NO.	
1.Bc	obbin			RM-10 Chang Chun Plastics Co., Ltd.		E59481(S)	
2.Cc	ore	FERRITE RM10 R2K (GAP)		e RM-10 g Da Co., Ltd.			
2.11/		UEY 130°C	Hoi Luen E	Electrical MFR Co., Ltd.		E164409	
3.W	ire	ТЕХ-Е 130°С	Shenzhen C Co., Ltd.	Changyuan Electronic M	laterial	E249037	
4.Va	arnish	48562/C 155⁰C	Hang Cheu	ng Petrochemical Ltd.		E200154	
5.Ta	pe	MYLAR TAPE (PZ-YELLOW)					E165111(N)
6.Tu	lbe	TEFOLN 200°C 150V	Shenzhen V Co., Ltd.	Shenzhen Woer Heat Shrinkable Material Co., Ltd.		E203950	
7.Te	erminals	Tin coated- Copper wire	Will Fore Special Wire Corp.				
8.Sh	ield	Copper foil	Bo Tong Control (copper foil	o., Ltd. l:T0.025mm×7mm+7	TAPE)		
9.SC	OLDER	96.5% Su 3% Ag 0.5% Cu	Xin Yuan Co., Ltd.				
					1		
NIT	m/m	DR	AWN	CHECK	TITLE	TRANS	
TEL	(02)29450)2)29450588 Ci wu		Guo long Huang	IDENT NO.	TRN-0237	
AX (02)29447647 26-1, Lane 128, Sec. 2, gnan Rd., Jhonghe City, bei County 235, Taiwan		jei indus	STRIAL CO., LTD.	DWG NO.	19903 KB773-9192		





8. Revision History

Rev.	Date	Description		
1.0.0	February 2012	Initial Release		
1.0.1	January 2013	Correct some error in parameter usage and naming in descriptions, added non breaking space before UNOM.		

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Replace components on the Evaluation Board only with those parts shown on the parts list (or Bill of Materials) in the Users' Guide. Contact an authorized Fairchild representative with any questions.

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